LT5526 Downconverting Mixer

## feATURES

- Operation up to 2 GHz
- Broadband RF, LO and IF Operation
- High Input IP3: +16.5dBm at 900MHz
- Typical Conversion Gain: 0.6 dB at 900 MHz
- SSB Noise Figure: 11dB at 900MHz
- On-Chip $50 \Omega$ LO Match
- Integrated LO Buffer: -5dBm Drive Level
- High LO-RF and LO-IF Isolation
- Low Supply Current: 28mA Typ
- Enable Function
- Single 5V Supply
- 16-Lead QFN (4mm $\times 4 \mathrm{~mm})$ Package


## APPLICATIONS

- Point-to-Point Data Communication Systems
- Wireless Infrastructure
- Cable Downlink Infrastructure
- High Linearity Receiver Applications


## DESCRIPTIOn

The $\mathrm{LT}{ }^{\circledR} 5526$ is a low power broadband mixer optimized for high linearity applications such as point-to-point data transmission, cable infrastructure and wireless infrastructure systems. The device includes an internally matched high speed LO amplifier driving a double-balanced active mixer core. An integrated RF buffer amplifier provides excellent LO-RF isolation. The RF and IF ports can be easily matched across a broad range of frequencies for use in a wide variety of applications.

The LT5526 offers a high performance alternative to passive mixers. Unlike passive mixers which have conversion loss and require high LO drive levels, the LT5526 delivers conversion gain at significantly lower LO input levels and is much less sensitive to LO power level variations.
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## TYPICAL APPLICATION

High Signal Level Frequency Downconversion


IF Output Power and IM3 vs RF Input Power (Two Input Tones)


5526 TA02
ABSOLUTE MAXIMUM RATINGS(Note 1)
Supply Voltage ..... 5.5 V
Enable Voltage ..... -0.3 V to $\mathrm{V}_{\mathrm{Cc}}+0.3 \mathrm{~V}$
LO Input Power ..... $+10 \mathrm{dBm}$
LO+ to LO- Differential DC Voltage ..... $\pm 1 \mathrm{~V}$
RF Input Power ..... $+10 \mathrm{dBm}$
$\mathrm{RF}^{+}$to $\mathrm{RF}^{-}$Differential DC Voltage ..... $\pm 0.7 \mathrm{~V}$
Operating Temperature Range

$\qquad$
$-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$
Storage Temperature Range ..... $-65^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) ..... $125^{\circ} \mathrm{C}$

PACKAGE/ORDER INFORMATION

| UF PACKAGE <br> 16-LEAD ( $4 \mathrm{~mm} \times 4 \mathrm{~mm}$ ) PLASTIC QFN $\mathrm{T}_{\mathrm{JMAX}}=125^{\circ} \mathrm{C}, \theta_{\mathrm{JA}}=37^{\circ} \mathrm{C} / \mathrm{W}$ <br> EXPOSED PAD (PIN 17) IS GND, <br> MUST BE SOLDERED TO PCB. <br> NC PINS SHOULD BE GROUNDED | ORDER PART NUMBER |
| :---: | :---: |
|  | LT5526EUF |
|  | UF PART MARKING |
|  | 5526 |

Consult LTC Marketing for parts specified with wider operating temperature ranges.

## DC ELECTRICAL CHARACTGRISTICS

$V_{C C}=5 V, E N=3 V, T_{A}=25^{\circ} \mathrm{C}$ (Note 3), unless otherwise noted. Test circuit shown in Figure 1.

| PARAMETER | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power Supply Requirements (VCC) |  |  |  |  |  |
| Supply Voltage |  | 3.6 | 5 | 5.3 | V |
| Supply Current | $V_{\text {CC }}=5 \mathrm{~V}$ |  | 28 | 33 | mA |
| Shutdown Current | EN = Low |  |  | 100 | $\mu \mathrm{A}$ |
| Enable (EN) Low = Off, High = On |  |  |  |  |  |
| EN Input High Voltage (On) |  | 3 |  |  | V |
| EN Input Low Voltage (0ff) |  |  |  | 0.3 | V |
| Enable Pin Input Current | $\begin{aligned} & E N=5 V \\ & E N=0 V \end{aligned}$ |  | $\begin{gathered} 55 \\ 0.01 \end{gathered}$ |  | $\mu \mathrm{A}$ |
| Turn-On Time (Note 5) |  |  | 3 |  | $\mu \mathrm{S}$ |
| Turn-Off Time (Note 5) |  |  | 6 |  | $\mu \mathrm{S}$ |

## AC ELECTRICAL CHARACTERISTICS (Notes 2,3 )

| PARAMETER | CONDITIONS | MIN | TYP |
| :--- | :--- | ---: | ---: |
| RF Input Frequency Range (Note 4) | Requires RF Matching | 0.1 to 2000 | UNITS |
| LO Input Frequency Range (Note 4) | Requires DC Blocks | 0.1 to 2500 | MHz |
| IF Output Frequency Range (Note 4) | Requires IF Matching | 0.1 to 1000 | MHz |

$V_{C C}=5 V, E N=3 V, T_{A}=25^{\circ} \mathrm{C}$. Test circuits shown in Figures 1 and 2. (Notes 2, 3)

| PARAMETER | CONDITIONS | MIN | TYP |
| :--- | :--- | :---: | :---: |
| RF Input Return Loss | $Z_{0}=50 \Omega$, External Match | 15 | UNITS |
| LO Input Return Loss | $Z_{0}=50 \Omega$, External DC Blocks | $d B$ |  |
| IF Output Return Loss | $Z_{0}=50 \Omega$, External Match | 15 | $d B$ |
| LO Input Power |  | -10 to 0 | $d B$ |

AC ELECTRICAL CHARACTERISTICS
$\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{EN}=3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{RF}}=-15 \mathrm{dBm}(-15 \mathrm{dBm} /$ tone for 2-tone IIP3 tests, $\Delta f=1 \mathrm{MHz}$ ), $\mathrm{P}_{\mathrm{L} 0}=-5 \mathrm{dBm}$, unless otherwise noted. Test circuits shown in Figures 1 and 2. (Notes 2, 3)

| PARAMETER | CONDITIONS | MII | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RF to LO Isolation | $\begin{aligned} & f_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=420 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & 69 \\ & 55 \\ & 50 \end{aligned}$ |  | dB dB dB |
| Conversion Gain | $\mathrm{f}_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{L} 0}=420 \mathrm{MHz}$ <br> $\mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{L} 0}=760 \mathrm{MHz}$ <br> $\mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{L} 0}=1760 \mathrm{MHz}$ |  | $\begin{aligned} & 0.6 \\ & 0.6 \\ & 0.4 \end{aligned}$ |  | dB dB dB |
| Conversion Gain vs Temperature | $\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ |  | -0.013 |  | $\mathrm{dB} /{ }^{\circ} \mathrm{C}$ |
| Input 3rd Order Intercept | $\mathrm{f}_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{L} 0}=420 \mathrm{MHz}$ <br> $\mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz}$ <br> $\mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{L} 0}=1760 \mathrm{MHz}$ |  | $\begin{aligned} & 15.2 \\ & 16.5 \\ & 14.1 \end{aligned}$ |  |  |
| Single Sideband Noise Figure | $\begin{aligned} & f_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\text {IF }}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=420 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{fF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & 12.7 \\ & 11.0 \\ & 13.7 \end{aligned}$ |  | dB dB dB |
| LO to RF Leakage | $\begin{aligned} & \mathrm{f}_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\text {IF }}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=420 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{fF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & -65 \\ & -65 \\ & -55 \end{aligned}$ |  | dBm <br> dBm <br> dBm |
| LO to IF Leakage | $\begin{aligned} & f_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=420 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & \hline-56 \\ & -74 \\ & -37 \\ & \hline \end{aligned}$ |  | dBm <br> dBm <br> dBm |
| 2RF-2LO Output Spurious Product $\left(f_{R F}=f_{L O} \pm f_{I F} / 2\right)$ | $\begin{aligned} & \text { 350MHz: } f_{R F}=385 \mathrm{MHz} \text { at }-15 \mathrm{dBm}, \mathrm{f}_{\mathrm{LO}}=420 \mathrm{MHz} \\ & \text { 900MHZ: } \mathrm{f}_{\mathrm{RF}}=830 \mathrm{MHz} \text { at }-15 \mathrm{dBm}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz} \\ & 1900 \mathrm{MHz}: \mathrm{f}_{\mathrm{RF}}=1830 \mathrm{MHz} \text { at }-15 \mathrm{dBm}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & -75 \\ & -72 \\ & -48 \end{aligned}$ |  | dBC dBC dBC |
| 3RF-3LO Output Spurious Product $\left(f_{R F}=f_{L O} \pm f_{\mathrm{IF}} / 3\right)$ | $350 \mathrm{MHz}: \mathrm{f}_{\mathrm{RF}}=396.67 \mathrm{MHz}$ at $-15 \mathrm{dBm}, \mathrm{f}_{\mathrm{L} 0}=420 \mathrm{MHz}$ <br> $900 \mathrm{MHZ}: \mathrm{f}_{\mathrm{RF}}=806.67 \mathrm{MHz}$ at $-15 \mathrm{dBm}, \mathrm{f}_{\mathrm{L} 0}=760 \mathrm{MHz}$ <br> $1900 \mathrm{MHz}: \mathrm{f}_{\mathrm{RF}}=1806.67 \mathrm{MHz}$ at $-15 \mathrm{dBm}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz}$ |  | $\begin{aligned} & -65 \\ & -68 \\ & -56 \end{aligned}$ |  | dBC dBC dBC |
| Input 1dB Compression | $\begin{aligned} & f_{\mathrm{RF}}=350 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=70 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=420 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=760 \mathrm{MHz} \\ & \mathrm{f}_{\mathrm{RF}}=1900 \mathrm{MHz}, \mathrm{f}_{\mathrm{IF}}=140 \mathrm{MHz}, \mathrm{f}_{\mathrm{LO}}=1760 \mathrm{MHz} \end{aligned}$ |  | $\begin{aligned} & 5 \\ & 5 \\ & 1 \end{aligned}$ |  | dBm <br> dBm <br> dBm |

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.
Note 2: The 900 MHz and 1900 MHz performance is measured with the test circuit shown in Figure 1. The 350MHz performance is measured using the test circuit in Figure 2.
Note 3: Specifications over the $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ temperature range are assured by design, characterization and correlation with statistical process controls.

Note 4: Operation over a wider frequency range is possible with reduced performance. Consult the factory for information and assistance.
Note 5: Turn-on and turn-off times correspond to a change in the output level by 40dB.

TYPICAL AC PERFORMARC CHARACTERISTICS soontr application. Vcce $=5 v$, en $=3 V$,
$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{RF}}=-15 \mathrm{~dB}\left(-15 \mathrm{dBm} /\right.$ tone for 2-tone IIP3 tests, $\Delta \mathrm{f}=1 \mathrm{MHz}$ ), $\mathrm{f}_{\mathrm{L} 0}=\mathrm{f}_{\mathrm{RF}}-140 \mathrm{MHz}, \mathrm{P}_{\mathrm{L} 0}=-5 \mathrm{dBm}$, IF output measured at 140MHz, unless otherwise noted. Test circuit shown in Figure 1.

Conversion Gain, IIP3 and SSB NF vs RF Frequency (Low Side LO)


5526 G01
Conversion Gain and IIP3 vs LO Input Power


5526 G04

## Conversion Gain and IIP3 <br> vs Supply Voltage



5526 G07

Conversion Gain, IIP3 and SSB NF vs RF Frequency (High Side LO)


5526 G02
SSB Noise Figure
vs LO Input Power


RF, LO and IF Port Return Loss vs Frequency


Conversion Gain, IIP3 and SSB NF vs Temperature


5526 G03

## LO-IF and LO-RF Leakage vs LO Input Frequency



IF Output Power and IM3 vs RF Input Power (Two Input Tones)


TYPICAL AC PGRFORMAOCE CHARACTERISTICS 900mHz Application. $\mathrm{V}_{\mathrm{cc}}=5 \mathrm{~V}, \mathrm{EN}=3 \mathrm{~V}$, $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{RF}}=-15 \mathrm{~dB}(-15 \mathrm{dBm} /$ tone for 2-tone IIP3 tests, $\Delta \mathrm{f}=1 \mathrm{MHz}), \mathrm{f}_{\mathrm{LO}}=\mathrm{f}_{\mathrm{RF}}-140 \mathrm{MHz}, \mathrm{P}_{\mathrm{LO}}=-5 \mathrm{dBm}$, IF output measured at 140 MHz , unless otherwise noted. Test circuit shown in Figure 1.
$\mathrm{IF}_{\text {OUT }}, 2 \times 2$ and $3 \times 3$ Spurs vs RF Input Power

$2 \times 2$ and $3 \times 3$ Spurs vs LO Input Power


5526 G10
5526 G11
1900MHz Application. $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \mathrm{EN}=3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{RF}}=-15 \mathrm{~dB}(-15 \mathrm{dBm} /$ tone for 2-tone IIP3 tests, $\Delta \mathrm{f}=1 \mathrm{MHz})$, $f_{L 0}=f_{R F}-140 \mathrm{MHz}, P_{L 0}=-5 d B m$, IF output measured at 140 MHz , unless otherwise noted. Test circuit shown in Figure 1.


$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{P}_{\mathrm{RF}}=-15 \mathrm{~dB}\left(-15 \mathrm{dBm} /\right.$ tone for 2-tone IIP3 tests, $\Delta \mathrm{f}=1 \mathrm{MHz}$ ), $\mathrm{f}_{\mathrm{LO}}=\mathrm{f}_{\mathrm{RF}}+70 \mathrm{MHz}, \mathrm{P}_{\mathrm{LO}}=-5 \mathrm{dBm}$, IF output measured at 70MHz, unless otherwise noted. Test circuit shown in Figure 2.


TYPICAL DC PERFORMANC CHARACTERISTICS Test tircuit shown in Figure 1.


Shutdown Current vs Supply Voltage


5526 G25

## PIn functions

NC (Pins 1, 4, 8, 13, 16): Not Connected Internally. These pins should be grounded on the circuit board for improved LO-to-RF and LO-to-IF isolation.

RF' $^{+}$, RF $^{-}$(Pins 2, 3): Differential Inputs for the RF Signal. These pins must be driven with a differential signal. Each pin must also be connected to a DC ground capable of sinking 7.5 mA ( 15 mA total). This DC bias return can be accomplished through the center-tap of a balun or with shunt inductors. An impedance transformation is required to match the RF input to $50 \Omega$ (or $75 \Omega$ ).
EN (Pin 5): Enable Pin. When the input voltage is higher than 3V, the mixer circuits supplied through Pins 6, 7, 10 and 11 are enabled. When the input voltage is less than 0.3 V , all circuits are disabled. Typical enable pin input current is $55 \mu \mathrm{~A}$ for $\mathrm{EN}=5 \mathrm{~V}$ and $0.01 \mu \mathrm{~A}$ when $\mathrm{EN}=0 \mathrm{~V}$.
$\mathbf{V}_{\text {CC1 }}$ (Pin 6): Power Supply Pin for the LO Buffer Circuits. Typical current consumption is 11 mA . This pin should be externally connected to the other $V_{\text {CC }}$ pins and decoupled with 100 pF and $0.01 \mu \mathrm{~F}$ capacitors.
$V_{\text {CC2 }}$ (Pin 7): Power Supply Pin for the Bias Circuits. Typical current consumption is 2.5 mA . This pin should be externally connected to the other $V_{C C}$ pins and decoupled with 100 pF and $0.01 \mu \mathrm{~F}$ capacitors.

GND (Pins 9, 12): Ground. These pins are internally connected to the Exposed Pad for better isolation. They should be connected to ground on the circuit board, though they are not intended to replace the primary grounding through the Exposed Pad of the package.
IF- and IF+ (Pins 10, 11): Differential Outputs for the IF Signal. An impedance transformation may be required to match the outputs. These pins must be connected to $\mathrm{V}_{\mathrm{CC}}$ through impedance matching inductors, RF chokes or a transformer center-tap.
$\mathrm{LO}^{-}, \mathrm{LO}^{+}$(Pins 14, 15): Differential Inputs for the Local Oscillator Signal. The LO input is internally matched to 50』; however, external DC blocking capacitors are required because these pins are internally biased to approximately 1.7V DC. Either LO input can be driven with a single-ended source while connecting the unused input to ground through a DC blocking capacitor.

Exposed Pad (Pin 17): Circuit Ground Return for the Entire IC. This must be soldered to the printed circuit board ground plane.

## BLOCK DIAGRAM



## TEST CIRCUITS



| REF DES | VALUE | SIZE | PART NUMBER | REF DES | VALUE | SIZE | PART NUMBER |
| :--- | :---: | :---: | :--- | :--- | :---: | :---: | :---: |
| C 1 | 2.7 pF | 0402 | AVX 04025A2R7CAT | L2, L3 | 150 nH | 1608 | Toko LL1608-FSR15J |
| C 2 | $0.01 \mu \mathrm{~F}$ | 0402 | AVX 04023C103JAT | T1 | $1: 1$ | 1206 | Murata LDB31900M05C-417 |
| C 3 | 1.2 pF | 0402 | AVX 04025A1R2BAT | T2 | $4: 1$ | SM-22 | M/A-COM ETC4-1-2 |
| $\mathrm{C4}, \mathrm{C} 5, \mathrm{C} 6$ | 100 pF | 0402 | AVX 04025A101JAT | TL1, TL2 | $\mathrm{Z}_{0}=80$ | $\mathrm{~L}=1.25 \mathrm{~mm}$ |  |
| $\mathrm{C8}$ | $1 \mu \mathrm{~F}$ | 0603 | Taiyo Yuden LMK107BJ105MA |  |  |  |  |

Figure 1. Test Schematic for 900MHz Application. For 1900MHz or Other Applications, Component Values Are as Indicated in Figure 1 and in Applications Section


| REF DES | VALUE | SIZE | PART NUMBER | REF DES | VALUE | SIZE | PART NUMBER |
| :--- | :---: | :---: | :--- | :--- | :---: | :---: | :---: |
| C2 | 0.01 pF | 0402 | AVX 04023C103JAT | L1, L4 | 15 nH | 1005 | Toko LL1005-FH15NJ |
| C3 | $3.9 p F$ | 0402 | AVX 04025A3R9BAT | L2, L3 | 270 nH | 1608 | Toko LL1608-FSR27J |
| C4, C5, C6 | 100 pF | 0402 | AVX 04025A101JAT | L5 | 100 nH | 1005 | Toko LL1005-FHR10J |
| C8 | $1 \mu \mathrm{~F}$ | 0603 | Taiyo Yuden LMK107BJ105MA | T2 | $4: 1$ | SM-22 | M/A-COM ETC4-1-2 |
| C7, C9 | 10 pF | 0402 | AVX 04025A100JAT |  |  |  |  |

Figure 2. Test Schematic for 350MHz Applications

## APPLICATIONS INFORMATION

The LT5526 consists of a double-balanced mixer, RF buffer amplifier, high speed limiting LO buffer and bias/enable circuits. The IC has been optimized for downconverter applications with RF input signals to 2GHz and LO signals to 2.5 GHz . With proper matching, the IF output can be tuned for operation at frequencies from 0.1 MHz to 1 GHz . Operation over a wider input frequency range is possible, though with reduced performance.

The RF, LO and IF ports are all differential, though the LO port is internally matched for single-ended drive (with external DC blocking capacitors). The LT5526 is characterized and production tested using single-ended LO drive. Low side or high side LO injection can be used.

## RF Input Port

Figure 3 shows a simplified schematic of the internal RF input circuit and example external impedance matching components for a 900MHz application. Each RF input pin requires a low resistance DC return to ground capable of handling 7.5 mA . The DC ground can be realized using the center-tap of an input transformer (T1), as shown, or through matching inductors or bias chokes connected from Pins 2 and 3 to ground.

A lowpass impedance matching network is used to transform the differential input impedance at Pins 2 and 3 to the optimum value for the balun output, as illustrated in Figures 3 and 4. To assist in matching, Table 1 lists the differential input impedance and reflection coefficient at Pins 2 and 3 for several RF frequencies. The following example demonstrates how to design a lowpass impedance transformation network for the RF input.

From Table 1, the differential input impedance at 900 MHz is: $R_{R F}+j X_{R F}=31.3+j 8.41 \Omega$. The $8.41 \Omega$ reactance is divided into two halves, with one half on each side of the $31.3 \Omega$ internal load resistor, as shown in Figure 4. The matching network consists of additional external series inductance and a capacitor (C1) in parallel with the desired source impedance ( $50 \Omega$ in this example). The external capacitance and inductance are calculated as follows:

$$
\begin{aligned}
& \mathrm{n}=\mathrm{R}_{\mathrm{S}} / \mathrm{R}_{\mathrm{RF}}=50 / 31.3=1.597 \\
& \mathrm{Q}=\sqrt{(\mathrm{n}-1)}=0.773 \\
& X_{C}=\mathrm{R}_{\mathrm{S}} / \mathrm{Q}=64.7 \Omega \\
& \mathrm{C} 1=1 /\left(\omega \cdot X_{C}\right)=2.74 \mathrm{pF} \\
& X_{\mathrm{L}}=\mathrm{R}_{\mathrm{RF}} \cdot \mathrm{Q}=24.2 \Omega \\
& X_{\mathrm{EXT}}=X_{\mathrm{L}}-X_{\mathrm{RF}}=15.8 \Omega \\
& \mathrm{~L}_{\mathrm{EXT}}=\mathrm{X}_{\mathrm{EXT}} / \omega=2.79 \mathrm{nH}
\end{aligned}
$$



Figure 3. RF Input with External Matching for 900MHz Application

## APPLICATIONS InFORMATION

The external inductance is split in half $(1.4 \mathrm{nH})$, with each half connected between the pin and C1 as shown in Figure 4. The inductance may be realized with short, high impedance printed transmission lines, as in Figure 3, which provides a compact board layout and reduced component count. A 1:1 transformer (T1 in Figure 3) converts the $50 \Omega$ differential impedance to a $50 \Omega$ singleended input.


Figure 4. RF Input Impedance Matching Topology

Table 1. RF Input Differential Impedance

| FREQUENCY (MHz) | INPUT IMPEDANCE | REFLECTION COEFFICIENT |  |
| :---: | :---: | :---: | :---: |
|  |  | MAG | ANGLE |
| 70 | 28.0 + j1.34 | 0.282 | 176 |
| 140 | $28.2+j 2.46$ | 0.280 | 172 |
| 240 | $28.4+\mathrm{j} 3.30$ | 0.278 | 169 |
| 360 | $28.4+\mathrm{j} 4.75$ | 0.282 | 164 |
| 450 | $28.6+j 5.42$ | 0.280 | 162 |
| 750 | $29.9+$ j7.39 | 0.268 | 155 |
| 900 | $31.3+j 8.41$ | 0.251 | 150 |
| 1500 | $38.3+$ j17.9 | 0.237 | 112 |
| 1900 | $42.5+\mathrm{j} 24.6$ | 0.269 | 92.2 |

An alternative method of driving the RF input is to use a lumped-element balun configuration, as shown in Figure 5. This type of network may provide a more costeffective solution for narrow band applications (fractional bandwidths $<30 \%$ ). The actual balun is composed of components C7, C9, L1 and L4, and their values may be estimated as follows:


Figure 5. Schematic of Lumped Element Input Balun

$$
\begin{aligned}
& \mathrm{L} 1=\mathrm{L} 4=\frac{\sqrt{\mathrm{R}_{\mathrm{S}} \bullet \mathrm{R}_{\mathrm{RF}}}}{\omega} \\
& \mathrm{C} 7=\mathrm{C} 9=\frac{1}{\omega \sqrt{\mathrm{R}_{\mathrm{S}} \bullet \mathrm{R}_{\mathrm{RF}}}}
\end{aligned}
$$

Where $R_{S}$ is the source resistance ( $50 \Omega$ ) and $R_{R F}$ is the mixer input resistance from Table 1.

The computed values are only approximate, as they don't factor in the effects of $X_{R F}$ or the parasitics of the external components. Actual component values for several frequencies are listed in Table 2, and measured return loss vs. frequency is plotted for each example in Figure 6.


Figure 6. Input Return Loss with Lumped Element Baluns Using Values from Table 2

## APPLICATIONS InFORMATION

The purpose of L 5 is to provide a DC return path for $\operatorname{Pin} 3$. (Another possible placement for L5 would be across Pins 2 and 3, thus using L1 as part of the DC return path.) The inductance and resonant frequency of L5 should be large enough that they don't significantly affect the input impedance and performance of the balun. Either multilayer or wire-wound inductors may be used.

The impact of L 5 on input matching can be reduced by adding a capacitor in parallel with it. In this case, the capacitor value should be the same as C7 and C9, while L5 should have the same value as L1 and L4.
Table 2. Component Values for Lumped Balun on RF Input

| FREQUENCY <br> $(\mathbf{M H z})$ | $\mathbf{L}(\mathbf{n H})$ | $\mathbf{C}(\mathbf{p F})$ | $\mathbf{L 5}(\mathbf{n H})$ | BANDWIDTH <br> $\mathbf{( M H z )}$ |
| :---: | :---: | :---: | :---: | :---: |
| 240 | 27 | 18 | 100 | 100 |
| 380 | 15 | 10 | 100 | 130 |
| 680 | 6.8 | 4.7 | 47 | 215 |
| 900 | 6.8 | 3.9 | 18 | 230 |
| 1100 | 3.9 | 2.7 | 15 | 230 |

## LO Input Port

The LO buffer amplifier consists of high speed limiting differential amplifiers designed to drive the mixer core for high linearity. The $\mathrm{LO}^{+}$and $\mathrm{LO}^{-}$pins are designed for singleended drive, though differential drive can be used if desired. The LO input is internally matched to $50 \Omega$; however, external DC blocking capacitors are required because the LO pins are internally biased to approximately 1.7V DC. A simplified schematic for the LO input is shown in Figure 7.


Figure 7. LO Input Schematic

External 100pF DC blocking capacitors provide a broadband match from about 110 MHz to 2.7 GHz , as shown in the plot of return loss vs frequency in Figure 8. The LO input match can be improved at lower frequencies by increasing the values of C 5 and C 6 .


5526 F08
Figure 8. Typical LO Input Return Loss with 100 pF DC Blocking Capacitors

Table 3. Single-Ended LO Input Impedance

| FREQUENCY | INPUT | REFLECTION COEFFICIENT |  |
| :---: | :---: | :---: | :---: |
| (MHz) | IMPEDANCE | MAG | ANGLE |
| 400 | $63.4-\mathrm{j} 12.0$ | 0.158 | -35.8 |
| 600 | $61.6-\mathrm{j} 8.38$ | 0.128 | -31.5 |
| 800 | $61.8-\mathrm{j} 6.86$ | 0.122 | -26.6 |
| 1000 | $62.4-\mathrm{j} 7.09$ | 0.127 | -26.1 |
| 1200 | $62.8-\mathrm{j} 8.32$ | 0.135 | -28.8 |
| 1400 | $62.6-\mathrm{j} 10.3$ | 0.144 | -34.0 |
| 1600 | $61.9-\mathrm{j} 12.6$ | 0.154 | -40.3 |
| 1800 | $60.5-\mathrm{j} 14.4$ | 0.160 | -46.2 |

## IF Output Port

A simplified schematic of the IF output circuit is shown in Figure 9. The output pins, $\mathrm{IF}^{+}$and $\mathrm{IF}^{-}$, are internally connected to the collectors of the mixer switching transistors. Both pins must be biased at the supply voltage, which can be applied through the center-tap of a transformer or

## APPLICATIONS InFORMATION

through impedance-matching inductors. Each IF pindraws about 7.5 mA of supply current ( 15 mA total). For optimum single-ended performance, these differential outputs must be combined externally through an IF transformer or balun.


Figure 9. IF Output with External Matching
An equivalent small-signal model for the output is shown in Figure 10. The output impedance can be modeled as a $575 \Omega$ resistor in parallel with a 0.7 pF capacitor. For most applications, the bond-wire inductance ( 0.7 nH per side) can be ignored.


Figure 10. IF Output Small-Signal Model
The external components, C3, L2 and L3 form an impedance transformation network to match the mixer output impedance to the input impedance of transformer T2. The values for these components can be estimated using the same equations that were used for the input matching
network, along with the impedance values listed in Table 4. As an example, at an IF frequency of 140 MHz and $R_{L}=$ 200 $\Omega$ (using a 4:1 transformer for T2),

$$
\begin{aligned}
& n=R_{I F} / R_{L}=574 / 200=2.87 \\
& Q=\sqrt{(n-1)}=1.368 \\
& X_{C}=R_{I F} / Q=420 \Omega \\
& C=1 /\left(\omega \cdot X_{C}\right)=2.71 p F \\
& C 3=C-C_{I F}=2.01 \mathrm{pF} \\
& X_{L}=R_{L} \cdot Q=274 \Omega \\
& L 2=L 3=X_{L} / 2 \omega=156 \mathrm{nH}
\end{aligned}
$$

Table 4. IF Differential Impedance (Parallel Equivalent)

| FREQUENCY (MHz) | OUTPUT IMPEDANCE | REFLECTION COEFFICIENT |  |
| :---: | :---: | :---: | :---: |
|  |  | MAG | ANGLE |
| 70 | 575\\|- j3.39k | 0.840 | -1.8 |
| 140 | 574\|| - j1.67k | 0.840 | -3.5 |
| 240 | 572\|| - j977 | 0.840 | -5.9 |
| 450 | 561\|| - j519 | 0.838 | -11.1 |
| 750 | 537\||- j309 | 0.834 | -18.6 |
| 860 | 525\|| - j267 | 0.831 | -21.3 |
| 1000 | 509\||- j229 | 0.829 | -24.8 |
| 1250 | 474\||- j181 | 0.822 | -31.3 |
| 1500 | 435\|| - j147 | 0.814 | -38.0 |

## Low Cost Output Match

For low cost applications in which the required fractional bandwidth of the IF output is less than $25 \%$, it may be possible to replace the output transformer with a lumpedelement network similar to that discussed earlier for the RF input. This circuit is shown in Figure 11, where L11, L12, C11 and C12 form a narrowband bridge balun. These element values are selected to realize a $180^{\circ}$ phase shift at the desired IF frequency and can be estimated by using the equations below. In this case, $\mathrm{R}_{\mathrm{IF}}$ is the mixer output resistance and $R_{L}$ is the load resistance ( $50 \Omega$ ).

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$$
\begin{aligned}
& \mathrm{L} 11=\mathrm{L} 12=\frac{\sqrt{\mathrm{R}_{\mathrm{IF}} \bullet \mathrm{R}_{\mathrm{L}}}}{\omega} \\
& \mathrm{C} 11=\mathrm{C} 12=\frac{1}{\omega \sqrt{\mathrm{R}_{\mathrm{IF}} \bullet \mathrm{R}_{\mathrm{L}}}}
\end{aligned}
$$

Inductors L13 and L14 provide a DC path between V CC and the $\mathrm{IF}^{+}$pin. Only one of these inductors is required. Low cost multilayer chip inductors are adequate for L11, L12 and L13. If L14 is used instead of L13, a larger value is usually required, which may require the use of a wirewound inductor. Capacitor C13 is a DC block which can also be used to adjust the impedance match. Capacitor C14 is a bypass capacitor.


Figure 11. Narrowband Bridge IF Balun

Typical return loss of the IF output port is plotted versus frequency in Figure 12 for a 240 MHz balun design. For this example, $\mathrm{L} 11=\mathrm{L} 12=100 \mathrm{nH}, \mathrm{C} 11=\mathrm{C} 12=3.9 \mathrm{pF}, \mathrm{L} 14=$ 560 nH and $\mathrm{C} 13=100 \mathrm{pF}$. Performance versus IF output frequency is shown in Figure 13 in the case of a 1900MHz RF input. These results show that the usable IF bandwidth is greater than 60 MHz , assuming tight tolerance matching components. Contact the factory for applications assistance with this circuit.


Figure 12. Typical Return Loss Performance with a 240 MHz Narrowband Bridge IF Balun (Swept IF)


Figure 13. Typical Gain and IIP3 Performance with a 240MHz Narrowband Bridge IF Balun (Swept IF)

## TYPICAL APPLICATIONS

Evaluation Board Layouts

Top Layer Silkscreen


PACKAGE DESCRIPTION
UF Package
16-Lead Plastic QFN ( $4 \mathrm{~mm} \times 4 \mathrm{~mm}$ )
(Reference LTC DWG \# 05-08-1692)


RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS


BOTTOM VIEW—EXPOSED PAD

NOTE:

1. DRAWING CONFORMS TO JEDEC PACKAGE OUTLINE MO-220 VARIATION (WGGC)
2. DRAWING NOT TO SCALE
3. ALL DIMENSIONS ARE IN MILLIMETERS
4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15 mm ON ANY SIDE
5. EXPOSED PAD SHALL BE SOLDER PLATED
6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

## RELATED PARTS

| PART NUMBER | DESCRIPTION | COMMENTS |
| :---: | :---: | :---: |
| Infrastructure |  |  |
| LT5511 | High Linearity Upconverting Mixer | RF Output to 3GHz, 17dBm IIP3, Integrated LO Buffer |
| LT5512 | DC-3GHz High Signal Level Downconverting Mixer | DC to 3GHz, 21dBm IIP3, Integrated LO Buffer |
| LT5514 | Ultralow Distortion, IF Amplifier/ADC Driver with Digitally Controlled Gain | 850 MHz Bandwidth, 47 dBm OIP3 at $100 \mathrm{MHz}, 10.5 \mathrm{~dB}$ to 33 dB Gain Control Range |
| LT5515 | 1.5 GHz to 2.5GHz Direct Conversion Quadrature Demodulator | 20dBm IIP3, Integrated LO Quadrature Generator |
| LT5516 | 0.8 GHz to 1.5 GHz Direct Conversion Quadrature Demodulator | 21.5dBm IIP3, Integrated LO Quadrature Generator |
| LT5517 | 40MHz to 900MHz Quadrature Demodulator | 21 dBm IIP3, Integrated LO Quadrature Generator |
| LT5519 | 0.7GHz to 1.4GHz High Linearity Upconverting Mixer | 17.1 dBm IIP3 at 1 GHz , Integrated RF Output Transformer with $50 \Omega$ Matching, Single-Ended LO and RF Ports Operation |
| LT5520 | 1.3GHz to 2.3GHz High Linearity Upconverting Mixer | 15.9 dBm IIP3 at 1.9 GHz , Integrated RF Output Transformer with $50 \Omega$ Matching, Single-Ended LO and RF Ports Operation |
| LT5521 | 3.7GHz Very High Linearity Mixer | 24.2dBm IIP3 at 1.95GHz, 12.5dB SSBNF, -42dBm LO Leakage, Supply Voltage $=3.15 \mathrm{~V}$ to 5.25 V |
| LT5522 | 600MHz to 2.7GHz High Signal Level Downconverting Mixer | 4.5 V to 5.25 V Supply, 25 dBm IIP3 at $900 \mathrm{MHz}, \mathrm{NF}=12.5 \mathrm{~dB}$, $50 \Omega$ Single-Ended RF and LO Ports |

## RF Power Detectors

| LT5504 | 800MHz to 2.7GHz RF Measuring Receiver | 80 dB Dynamic Range, Temperature Compensated, <br> 2.7 V to 5.25V Supply |
| :--- | :--- | :--- |
| LTC 5505 | RF Power Detectors with >40dB Dynamic Range | 300 MHz to 3GHz, Temperature Compensated, 2.7V to 6V Supply |
| LTC5507 | 100 kHz to 1000MHz RF Power Detector | 100 kHz to 1GHz, Temperature Compensated, 2.7V to 6V Supply |
| LTC5508 | 300 MHz to 7GHz RF Power Detector | 44 dB Dynamic Range, Temperature Compensated, SC70 Package |
| LTC5509 | 300 MHz to 3GHz RF Power Detector | 36 dB Dynamic Range, Low Power Consumption, SC70 Package |
| LTC5530 | 300 MHz to 7GHz Precision RF Power Detector | Precision Vout Offset Control, Shutdown, Adjustable Gain |
| LTC5531 | 300 MHz to 7GHz Precision RF Power Detector | Precision Vout Offset Control, Shutdown, Adjustable Offset |
| LTC5532 | 300 MHz to 7GHz Precision RF Power Detector | Precision Vout Offset Control, Adjustable Gain and Offset |
| LT5534 | 50 MHz to 3GHz RF Power Detector with 60dB Dynamic Range | $\pm 1 \mathrm{~dB}$ Output Variation over Temperature, 38ns Response Time |

## Low Voltage RF Building Blocks

| LT5500 | 1.8GHz to 2.7GHz Receiver Front End | 1.8 V to 5.25V Supply, Dual-Gain LNA, Mixer, LO Buffer |
| :--- | :--- | :--- |
| LT5502 | 400MHz Quadrature IF Demodulator with RSSI | 1.8 V to 5.25 V Supply, 70 MHz to 400MHz IF, 84dB Limiting Gain, <br> 90 dB RSSI Range |
| LT5503 | 1.2 GHz to 2.7GHz Direct IQ Modulator and <br> Upconverting Mixer | 1.8 V to 5.25 V Supply, Four-Step RF Power Control, <br> 120 MHz Modulation Bandwidth |
| LT5506 | 500 MHz Quadrature IF Demodulator with VGA | 1.8 V to 5.25 V Supply, 40MHz to 500MHz IF, -4dB to 57dB <br> Linear Power Gain, 8.8MHz Baseband Bandwidth |
| LT5546 | 500MHz Ouadrature IF Demodulator with <br> VGA and 17MHz Baseband Bandwidth | 17 MHz Baseband Bandwidth, 40MHz to 500MHz IF, 1.8V to 5.25V <br> Supply, -7dB to 56dB Linear Power Gain |

## Wide Bandwidth ADCs

| LT1749 | 12-Bit, 80Msps | 500 MHz BW S/H, 71.8dB SNR, 87dB SFDR |
| :--- | :--- | :--- |
| LT1750 | 14-Bit, 80Msps | 500 MHz BW S/H, 75.5dB SNR, 90dB SFDR, 2.25Vp-p or 1.35Vp-p <br> Input Ranges |

